Design Objectives of the 0.35µm Alpha 21164 Microprocessor (A 500MHz Quad Issue RISC Microprocessor)

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Outline

- 0.35µm Alpha 21164 Overview
- Design Goals
- Technology Issues
- 21164 Internal Architecture Review
- Architectural Enhancements
- System Performance Enhancements
- Alpha Processor RoadMap
- Summary

0.35µm ALPHA 21164

Technology shrink of 0.5µm design

 + Architectural Enhancements
 + System Performance Enhancements



Transistor Count Die Size Power Supply

WC Power Dissipation Target Cycle Time

0.5 μm process
9.3 Million
16.5 mm x 18.1 mm
3.3V external
3.3V internal
50W @ 300 MHz
300 MHz



0.35 µm process 9.66 Million 14.4 mm x 14.5 mm 3.3V external 2.5V internal 37W @ 433 MHz 433 MHz

Design Goals

- Reduced Cost
 - Die size reduction
 - Remove processing steps

• Higher Performance

- 433 MHz design target
- Architectural enhancements

Reduced Power

- Lower Core Operating Voltage (2.0v-2.5v)
- Time to Market
 - Significant leverage from previous design

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Die Size Analysis

Original 25% shrink	<u>X-dim</u> 16.5 - 4.1	<u>Y-dim</u> 18.1 - 4.5	<u>NormA</u> 1.00	Original Die 16.5mm x 18.1mm 298 mm ²	
	12.4	13.6	0.56		
Conversion LI Removal	+0.0 12.6 +1.8 14.4	+0.8 14.5 +0.0 14.5	0.62	Actual shrink 14.4mm x 14.5mm 209 mm ²	
Actual	14.4	14.5	0.70	Ideal 30% shrink	
Ideal 30%	11.5	12.7	0.49	11.5mm x 12.7mm 146 mm ²	

Layout Conversion Strategy

- Full 30% linear shrink was not possible
- Solution:
 - 25% linear shrink
 - Semi-automated conversion of design rules
 - Polysilicon mask layer pushed to full 30% shrink dimensions for performance
- Redesign of caches
 - Local Interconnect removed

Layout Conversion Example



Original

After Script

Final

Speed

- Single-wire, two phase clocking scheme
- 14 gates per cycle including latches
- Single global clock grid
 - Global clock skew<90ps
 - Local clock skew<25ps
- Clock statistics (0.5 µm design)
 - Clock load = 3.75 nF
 - Size of final clock inverter = 58 cm
 - Edge rate = 0.5 ns
 - Clocking consumes 40% of chip power
 - di/dt = 50 A

Speed Verification

- Test circuits were used to determine the speed scaling of different circuit configurations
 - Predicted average process speed up
 - Identified "slow" circuit types
- New circuits were evaluated in SPICE
- Chip sections with major modifications were completely re-verified

Power

- Significant Power Reduction
- Vddi = 2.2v (to 2.5v)
- 3.3V only interface to external devices





Alpha 21164 Features

Key Attributes

- 4-way issue superscalar
 - Up to 2 Integer AND 2 Floating Point instructions issued per CPU cycle.

• Large on-chip L2 cache

– 96KB, writeback, 3-way set associative

• Fully Pipelined

- 7-stage integer pipeline
- 9-stage floating point pipeline
- Emphasis on low latency at high clock rate
- High-throughput memory subsystem

Alpha 21164 Block Diagram



Instruction Issue Pipeline Review



Execution Pipeline Review



On-chip Cache Resources Review



L3 Cache (off-chip)



- L3 cache is a direct-mapped writeback superset of onchip L2 cache
- Up to 2 reads (or outstanding read commands) in L3 cache
- Programmable wave pipelining for L3 cache
- Support for Synchronous Flow-Thru SRAMs
- L3 cache is optional

Off-Chip L3 Cache Options

Selectable via on-chip programmable registers

- ♦ Cache Size− 1 to 64M Byte
- ◆ Cache Read/Write Speed 4 to 15 cpu cycles
- Read to Write Spacing 1 to 7 cpu cycles
- Write Pulse (Bit Mask) Up to 9 cpu cycles
- Wave pipelining
 0 to 3 cpu cycles
- Support for Synchronous SRAM's

Architectural Enhancements

New Instructions

- Scalar support for Byte and Short data types
 - -LDBU, LDWU load an unsigned byte or short
 - STB, STW, store an byte or short
 - SEXTB, SEXTW sign extend a byte or short
- Eases porting of device drivers to Alpha
- Improves emulation of Intel code on Alpha
- Implemented in this and all future Alpha microprocessors

Architectural Enhancements

New Instructions (continued)

• IMPLVER

- returns a small integer indicating the core design
- used for code scheduling decisions
- implemented in all Alpha microprocessors
- AMASK
 - clears bits to indicate which features are present
 - implemented in all Alpha microprocessors

Example:

. . .

AMASK	#1, R0	;byte/word present
BNE	R0, emulate	;if not emulate

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System Performance Enhancements



Pre-Silicon Logic Verification

- Used extensive test suite developed for original chip as testing baseline
- Random and focused testing
- Coverage analysis to ensure excellent test coverage
- Three simulation systems used:
 - RTL
 - Transistor-level
 - Gate-level

Alpha Microprocessor Road Map *



Summary

- FIRST PASS SILICON October 1995
- Booted first operating system in 2 days!
- Continued Performance Leadership (4+ years)
- Look for next generation 30+ SpecInt95 by Q3'97

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